imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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5V ECL ÷4 Divider

Description

The MC10EL/100EL33 is an integrated ÷4 divider. The differential clock inputs and the V_{BB} allow a differential, single-ended or AC coupled interface to the device. The V_{BB} pin, an internally generated voltage supply, is available to this device only. For single-ended input conditions, the unused differential input is connected to V_{BB} as a switching reference voltage. V_{BB} may also rebias AC coupled inputs. When used, decouple V_{BB} and V_{CC} via a 0.01 μF capacitor and limit current sourcing or sinking to 0.5 mA. When not used, V_{BB} should be left open.

The reset pin is asynchronous and is asserted on the rising edge. Upon power-up, the internal flip-flops will attain a random state; the reset allows for the synchronization of multiple EL33's in a system.

The 100 Series contains temperature compensation.

Features

- 650 ps Propagation Delay
- 4.0 GHz Toggle Frequency
- ESD Protection: Human Body Model; > 1 kV, Machine Model; > 100 V
- PECL Mode Operating Range: $V_{CC} = 4.2 \text{ V}$ to 5.7 V with $V_{EE} = 0 \text{ V}$
- NECL Mode Operating Range: $V_{CC} = 0$ V with $V_{EE} = -4.2$ V to -5.7 V
- Internal Input Pulldown Resistors on CLK(s) and R.
- Meets or Exceeds JEDEC Spec EIA/JESD78 IC Latchup Test
- Moisture Sensitivity Level 1 For Additional Information, see Application Note AND8003/D
- Flammability Rating: UL 94 V-0 @ 0.125 in, Oxygen Index: 28 to 34
- Transistor Count = 95 devices
- Pb-Free Packages are Available

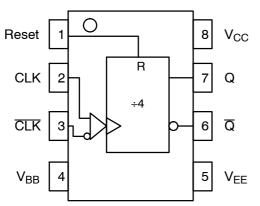
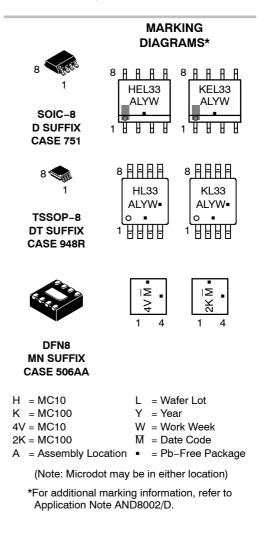


Figure 1. Logic Diagram and Pinout Assignment



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ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

Table 1. PIN DESCRIPTION

| Pin | Function |
|---|---|
| CLK, <u>CLK</u> Reset Q, Q V _{BB} V _{CC} V _{EE} EP | ECL Clock Inputs* ECL Asynch Reset* ECL Data Outputs Reference Voltage Output Positive Supply Negative Supply (DFN8 only) Thermal exposed pad must be connected to a sufficient thermal conduit. Electrically connect to the most negative supply (GND) or leave unconnected, floating open. |

*Pins will default low when left open.

Table 2. MAXIMUM RATINGS

| Symbol | Parameter | Condition 1 | Condition 2 | Rating | Unit |
|----------------------|--|--|---|-------------------|--------------|
| V _{CC} | PECL Mode Power Supply | V _{EE} = 0 V | | 8 | V |
| V_{EE} | NECL Mode Power Supply | $V_{CC} = 0 V$ | | -8 | V |
| VI | PECL Mode Input Voltage NECL Mode Input Voltage | V _{EE} = 0 V V _{CC} = 0 V | $\begin{array}{c} V_{I} \leq V_{CC} \\ V_{I} \geq V_{EE} \end{array}$ | 6 -6 | V V |
| l _{out} | Output Current | Continuous Surge | | 50 100 | mA mA |
| I _{BB} | V _{BB} Sink/Source | | | ± 0.5 | mA |
| T _A | Operating Temperature Range | | | -40 to +85 | °C |
| T _{stg} | Storage Temperature Range | | | -65 to +150 | °C |
| θ_{JA} | Thermal Resistance (Junction-to-Ambient) | 0 lfpm 500 lfpm | SOIC-8 SOIC-8 | 190 130 | °C/W °C/W |
| θ_{JC} | Thermal Resistance (Junction-to-Case) | Standard Board | SOIC-8 | 41 to 44 | °C/W |
| θ_{JA} | Thermal Resistance (Junction-to-Ambient) | 0 lfpm 500 lfpm | TSSOP-8 TSSOP-8 | 185 140 | °C/W °C/W |
| θ_{JC} | Thermal Resistance (Junction-to-Case) | Standard Board | TSSOP-8 | 41 to 44 \pm 5% | °C/W |
| θ_{JA} | Thermal Resistance (Junction-to-Ambient) | 0 lfpm 500 lfpm | DFN8 DFN8 | 129 84 | °C/W °C/W |
| T _{sol} | Wave Solder Pb Pb-Free | <2 to 3 sec @ 248°C <2 to 3 sec @ 260°C | | 265 265 | °C |
| θ_{JC} | Thermal Resistance (Junction-to-Case) | (Note 1) | DFN8 | 35 to 40 | °C/W |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. JEDEC standard multilayer board - 2S2P (2 signal, 2 power)

| | | | -40°C | | | 25°C | | | 85°C | | Γ |
|-----------------|---|------|-------|------|------|------|------|------|------|------|------|
| | | | -40 C | | 23 0 | | | 85 C | | | |
| Symbol | Characteristic | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | Unit |
| I _{EE} | Power Supply Current | | 27 | 33 | | 27 | 33 | | 27 | 33 | mA |
| V _{OH} | Output HIGH Voltage (Note 3) | 3920 | 4010 | 4110 | 4020 | 4105 | 4190 | 4090 | 4185 | 4280 | mV |
| V _{OL} | Output LOW Voltage (Note 3) | 3050 | 3200 | 3350 | 3050 | 3210 | 3370 | 3050 | 3227 | 3405 | mV |
| VIH | Input HIGH Voltage (Single-Ended) | 3770 | | 4110 | 3870 | | 4190 | 3940 | | 4280 | mV |
| VIL | Input LOW Voltage (Single-Ended) | 3050 | | 3500 | 3050 | | 3520 | 3050 | | 3555 | mV |
| V_{BB} | Output Voltage Reference | 3.57 | | 3.7 | 3.65 | | 3.75 | 3.69 | | 3.81 | V |
| VIHCMR | Input HIGH Voltage Common Mode Range (DIfferential Configuration) (Note 4) | 2.5 | | 4.6 | 2.5 | | 4.6 | 2.5 | | 4.6 | V |
| I _{IH} | Input HIGH Current | | | 150 | | | 150 | | | 150 | μA |
| IIL | Input LOW Current | 0.5 | | | 0.5 | | | 0.3 | | | μΑ |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

2. Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary +0.25 V / –0.5 V. 3. Outputs are terminated through a 50 Ω resistor to V_{CC} – 2.0 V.

4. V_{IHCMR} min varies 1:1 with V_{EE}, V_{IHCMR} max varies 1:1 with V_{CC}. The V_{IHCMR} range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between V_{PP}min and 1 V.

| | | -40°C | | | 25°C | | | 85°C | | | |
|-----------------|---|-------|-------|-------|-------|-------|-------|-------|-------|-------|------|
| Symbol | Characteristic | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | Unit |
| I _{EE} | Power Supply Current | | 27 | 33 | | 27 | 33 | | 27 | 33 | mA |
| V _{OH} | Output HIGH Voltage (Note 6) | -1080 | -990 | -890 | -980 | -895 | -810 | -910 | -815 | -720 | mV |
| V _{OL} | Output LOW Voltage (Note 6) | -1950 | -1800 | -1650 | -1950 | -1790 | -1630 | -1950 | -1773 | -1595 | mV |
| V _{IH} | Input HIGH Voltage (Single-Ended) | -1230 | | -890 | -1130 | | -810 | -1060 | | -720 | mV |
| V _{IL} | Input LOW Voltage (Single-Ended) | -1950 | | -1500 | -1950 | | -1480 | -1950 | | -1445 | mV |
| V_{BB} | Output Voltage Reference | -1.43 | | -1.30 | -1.35 | | -1.25 | -1.31 | | -1.19 | V |
| VIHCMR | Input HIGH Voltage Common Mode Range (DIfferential Configuration) (Note 7) | -2.5 | | -0.4 | -2.5 | | -0.4 | -2.5 | | -0.4 | V |
| I _{IH} | Input HIGH Current | | | 150 | | | 150 | | | 150 | μA |
| IIL | Input LOW Current | 0.5 | | | 0.5 | | | 0.3 | | | μA |

Table 4. 10EL SERIES NECL DC CHARACTERISTICS V_{CC} = 0.0 V; V_{EE} = -5.0 V (Note 5)

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

5. Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary +0.25 V / –0.5 V.

6. Outputs are terminated through a 50 Ω resistor to V_{CC} – 2.0 V. 7. V_{IHCMR} min varies 1:1 with V_{EE} , V_{IHCMR} max varies 1:1 with V_{CC} . The V_{IHCMR} range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between VPPmin and 1 V.

| | | | -40°C | | | 25°C | | 85°C | | | |
|-----------------|---|------|-------|------|------|------|------|------|------|------|------|
| Symbol | Characteristic | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | Unit |
| I_{EE} | Power Supply Current | | 27 | 33 | | 27 | 33 | | 31 | 37 | mA |
| V _{OH} | Output HIGH Voltage (Note 9) | 3915 | 3995 | 4120 | 3975 | 4045 | 4120 | 3975 | 4050 | 4120 | mV |
| V _{OL} | Output LOW Voltage (Note 9) | 3170 | 3305 | 3445 | 3190 | 3295 | 3380 | 3190 | 3295 | 3380 | mV |
| VIH | Input HIGH Voltage (Single-Ended) | 3835 | | 4120 | 3835 | | 4120 | 3835 | | 4120 | mV |
| V _{IL} | Input LOW Voltage (Single-Ended) | 3190 | | 3525 | 3190 | | 3525 | 3190 | | 3525 | mV |
| V_{BB} | Output Voltage Reference | 3.62 | | 3.74 | 3.62 | | 3.74 | 3.62 | | 3.74 | V |
| VIHCMR | Input HIGH Voltage Common Mode Range (DIfferential Configuration) (Note 10) | 2.5 | | 4.6 | 2.5 | | 4.6 | 2.5 | | 4.6 | V |
| I _{IH} | Input HIGH Current | | | 150 | | | 150 | | | 150 | μA |
| IIL | Input LOW Current | 0.5 | | | 0.5 | | | 0.5 | | | μA |

Table 5. 100EL SERIES PECL DC CHARACTERISTICS V_{CC} = 5.0 V; V_{EE} = 0.0 V (Note 8)

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

8. Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary +0.8 V / –0.5 V.

9. Outputs are terminated through a 50 Ω resistor to V_{CC} – 2.0 V.

V_{IHCMR} min varies 1:1 with V_{EE}, V_{IHCMR} max varies 1:1 with V_{CC}. The V_{IHCMR} range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between V_{PP}min and 1 V.

| | | | –40°C | | 25°C | | 85°C | | | | |
|-----------------|---|-------|-------|-------|-------|-------|-------|-------|-------|-------|------|
| Symbol | Characteristic | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | Unit |
| I _{EE} | Power Supply Current | | 27 | 33 | | 27 | 33 | | 31 | 37 | mA |
| V _{OH} | Output HIGH Voltage (Note 12) | -1085 | -1005 | -880 | -1025 | -955 | -880 | -1025 | -955 | -880 | mV |
| V _{OL} | Output LOW Voltage (Note 12) | -1830 | -1695 | -1555 | -1810 | -1705 | -1620 | -1810 | -1705 | -1620 | mV |
| V _{IH} | Input HIGH Voltage (Single-Ended) | -1165 | | -880 | -1165 | | -880 | -1165 | | -880 | mV |
| V _{IL} | Input LOW Voltage (Single-Ended) | -1810 | | -1475 | -1810 | | -1475 | -1810 | | -1475 | mV |
| V_{BB} | Output Voltage Reference | -1.38 | | -1.26 | -1.38 | | -1.26 | -1.38 | | -1.26 | V |
| VIHCMR | Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 13) | -2.5 | | -0.4 | -2.5 | | -0.4 | -2.5 | | -0.4 | V |
| I _{IH} | Input HIGH Current | | | 150 | | | 150 | | | 150 | μA |

Table 6. 100EL SERIES NECL DC CHARACTERISTICS $V_{CC} = 0.0 \text{ V}$; $V_{EE} = -5.0 \text{ V}$ (Note 11)

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

11. Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary +0.8 V / -0.5 V. 12. Outputs are terminated through a 50 Ω resistor to V_{CC} - 2.0 V.

13. V_{IHCMR} min varies 1:1 with V_{EE}, V_{IHCMR} max varies 1:1 with V_{CC}. The V_{IHCMR} range is referenced to the most positive side of the differential input signal. Normal operation is obtained if the HIGH level falls within the specified range and the peak-to-peak voltage lies between V_{PP}min and 1 V.

| | | | -40°C | | 25°C | | 85°C | | | | |
|--------------------------------------|---|------------|------------|------------|------------|------------|------------|------------|------------|------------|------|
| Symbol | Characteristic | Min | Тур | Max | Min | Тур | Max | Min | Тур | Max | Unit |
| f _{max} | Maximum Toggle Frequency | 3.4 | 4.2 | | 3.8 | 4.2 | | 3.8 | 4.2 | | GHz |
| t _{PLH} t _{PHL} | Propagation Delay CLK to Q Reset to Q | 560 400 | 670 540 | 860 700 | 610 460 | 700 550 | 810 660 | 640 570 | 740 480 | 840 670 | ps |
| t _{RR} | Set/Reset Recovery | 400 | 200 | | 400 | 200 | | 400 | 200 | | ps |
| V_{PP} | Input Swing (Note 15) | 150 | | 1000 | 150 | | 1000 | 150 | | 1000 | mV |
| t _{JITTER} | Cycle-to-Cycle Jitter | | 1.0 | | | 1.0 | | | 1.0 | | ps |
| t _r t _f | Output Rise/Fall Times Q (20% – 80%) | 100 | 225 | 350 | 100 | 225 | 350 | 100 | 225 | 350 | ps |

| Table 7. AC CHARACTERISTICS | S $V_{CC} = 5.0 \text{ V}; V_{EE} = 0.0 \text{ V}$ or | V _{CC} = 0.0 V; V _{EE} = -5.0 V (Note 14) |
|-----------------------------|--|---|
|-----------------------------|--|---|

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

14.10 Series: V_{EE} can vary +0.25 V / –0.5 V.

100 Series: VEE can vary +0.8 V / -0.5 V.

15. V_{PP} (min) is minimum input swing for which AC parameters guaranteed. The device has a DC gain of ~40.

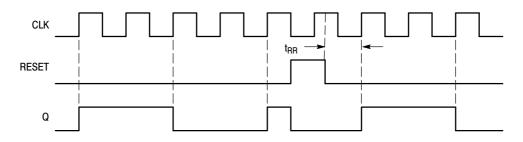
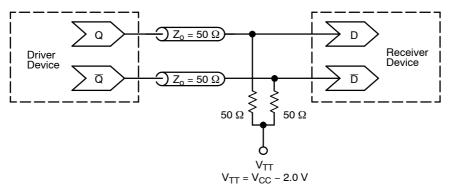
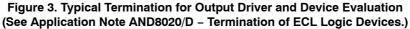


Figure 2. Timing Diagram





Resource Reference of Application Notes

| AN1405/D | - | ECL Clock Distribution Techniques |
|-----------|---|---|
| AN1406/D | - | Designing with PECL (ECL at +5.0 V) |
| AN1503/D | - | ECLinPS [™] I/O SPiCE Modeling Kit |
| AN1504/D | - | Metastability and the ECLinPS Family |
| AN1568/D | - | Interfacing Between LVDS and ECL |
| AN1672/D | - | The ECL Translator Guide |
| AND8001/D | - | Odd Number Counters Design |
| AND8002/D | - | Marking and Date Codes |
| AND8020/D | - | Termination of ECL Logic Devices |
| AND8066/D | _ | Interfacing with ECLinPS |
| AND8090/D | _ | AC Characteristics of ECL Devices |
| | | |

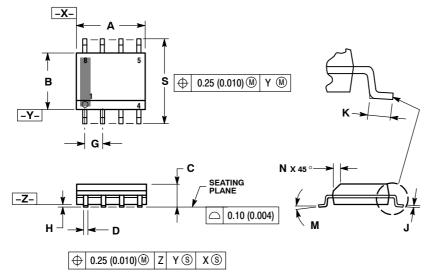
ORDERING INFORMATION

| Device | Package | Shipping [†] |
|----------------|----------------------|-----------------------|
| MC10EL33D | SOIC-8 | 98 Units / Rail |
| MC10EL33DG | SOIC-8 (Pb-Free) | 98 Units / Rail |
| MC10EL33DR2 | SOIC-8 | 2500 / Tape & Reel |
| MC10EL33DR2G | SOIC-8 (Pb-Free) | 2500 / Tape & Reel |
| MC10EL33DT | TSSOP-8 | 100 Units / Rail |
| MC10EL33DTG | TSSOP-8 (Pb-Free) | 100 Units / Rail |
| MC10EL33DTR2 | TSSOP-8 | 2500 / Tape & Reel |
| MC10EL33DTR2G | TSSOP-8 (Pb-Free) | 2500 / Tape & Reel |
| MC10EL33MNR4 | DFN8 | 1000 / Tape & Reel |
| MC10EL33MNR4G | DFN8 (Pb-Free) | 1000 / Tape & Reel |
| MC100EL33D | SOIC-8 | 98 Units / Rail |
| MC100EL33DG | SOIC-8 (Pb-Free) | 98 Units / Rail |
| MC100EL33DR2 | SOIC-8 | 2500 / Tape & Reel |
| MC100EL33DR2G | SOIC-8 (Pb-Free) | 2500 / Tape & Reel |
| MC100EL33DT | TSSOP-8 | 100 Units / Rail |
| MC100EL33DTG | TSSOP-8 (Pb-Free) | 100 Units / Rail |
| MC100EL33DTR2 | TSSOP-8 | 2500 / Tape & Reel |
| MC100EL33DTR2G | TSSOP-8 (Pb-Free) | 2500 / Tape & Reel |
| MC100EL33MNR4 | DFN8 | 1000 / Tape & Reel |
| MC100EL33MNR4G | DFN8 (Pb–Free) | 1000 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

SOIC-8 NB CASE 751-07 **ISSUE AH**



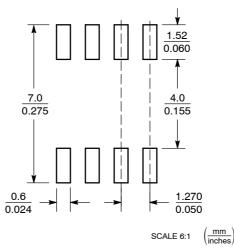
NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
 DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
 MAXIMUM MOLD PROTRUSION 0.15 (0.006)

- MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
 DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

| | MILLIN | IETERS | INC | HES | | |
|-----|--------|-------------|-----------|-------|--|--|
| DIM | MIN | MAX | MIN | MAX | | |
| Α | 4.80 | 5.00 | 0.189 | 0.197 | | |
| В | 3.80 | 4.00 | 0.150 | 0.157 | | |
| С | 1.35 | 1.35 1.75 (| | 0.069 | | |
| D | 0.33 | 0.33 0.51 | | 0.020 | | |
| G | 1.27 | 7 BSC | 0.050 BSC | | | |
| н | 0.10 | 0.25 | 0.004 | 0.010 | | |
| J | 0.19 | 0.25 | 0.007 | 0.010 | | |
| к | 0.40 | 1.27 | 0.016 | 0.050 | | |
| м | 0 ° | 8 ° | 0 ° | 8 ° | | |
| Ν | 0.25 | 0.50 | 0.010 | 0.020 | | |
| S | 5.80 | 6.20 | 0.228 | 0.244 | | |

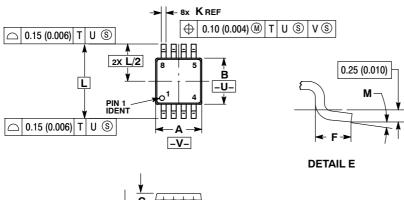
SOLDERING FOOTPRINT*

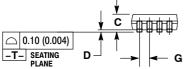


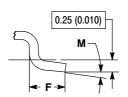
*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

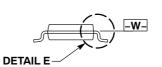
PACKAGE DIMENSIONS

TSSOP-8 DT SUFFIX PLASTIC TSSOP PACKAGE CASE 948R-02 **ISSUE A**









| | MILLIMETERS | | INCHES | |
|-----|-------------|------|-----------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 2.90 | 3.10 | 0.114 | 0.122 |
| В | 2.90 | 3.10 | 0.114 | 0.122 |
| С | 0.80 | 1.10 | 0.031 | 0.043 |
| D | 0.05 | 0.15 | 0.002 | 0.006 |
| F | 0.40 | 0.70 | 0.016 | 0.028 |
| G | 0.65 | BSC | 0.026 | BSC |
| K | 0.25 | 0.40 | 0.010 | 0.016 |
| L | 4.90 BSC | | 0.193 BSC | |
| М | 0° | 6 ° | 0° | 6 ° |

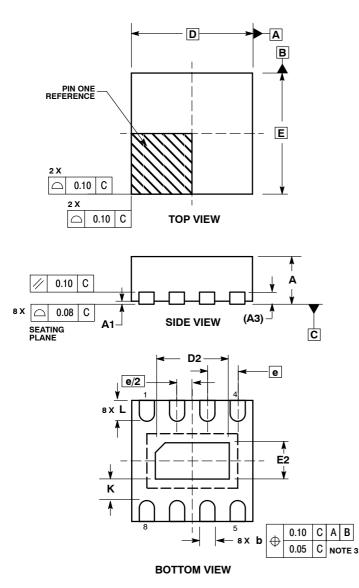
DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
 DIMENSION A DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
 DIMENSION & DOES NOT INCLUDE INTERLEAD.

(0.006) PER SIDE.
 DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
 TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
 DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

NOTES:

PACKAGE DIMENSIONS

DFN8 CASE 506AA-01 ISSUE D



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

 CONTROLING DIMENSION: MILLIMETERS.
 DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN

0.25 AND 0.30 MM FROM TERMINAL.4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

| | MILLIMETERS | | |
|-----|-------------|------|--|
| DIM | MIN | MAX | |
| Α | 0.80 | 1.00 | |
| A1 | 0.00 | 0.05 | |
| A3 | 0.20 REF | | |
| b | 0.20 | 0.30 | |
| D | 2.00 BSC | | |
| D2 | 1.10 | 1.30 | |
| Е | 2.00 BSC | | |
| E2 | 0.70 | 0.90 | |
| е | 0.50 BSC | | |
| к | 0.20 | | |
| L | 0.25 | 0.35 | |

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